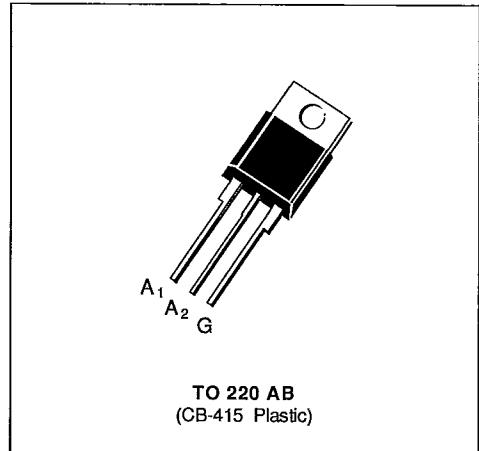


S G S-THOMSON

**SNUBBERLESS TRIACS**

- $I_{TRMS} = 12 \text{ A}$  at  $T_c = 85^\circ\text{C}$ .
- $V_{DRM}$  : 200 V to 800 V.
- $I_{GT} = 75 \text{ mA}$  (QI-II-III).
- GLASS PASSIVATED CHIP.
- HIGH SURGE CURRENT :  $I_{TSM} = 120 \text{ A}$ .
- HIGH COMMUTATION CAPABILITY :  $(di/dt)_c > 16 \text{ A/ms}$  without snubber.
- INSULATING VOLTAGE : 2500 V<sub>RMS</sub>.
- UL RECOGNIZED (E81734).

**DESCRIPTION**

New range suited for applications such as phase control and static switching on inductive or resistive load.

**ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit
$I_{TRMS}$	RMS on-state current (360 ° conduction angle)	12	A
$I_{TSM}$	Non repetitive surge peak on-state current ( $T_j$ initial = 25 °C)	$t = 8.3 \text{ ms}$	126
		$t = 10 \text{ ms}$	120
$I^2 t$	$I^2 t$ value	72	$\text{A}^2 \text{s}$
$di/dt$	Critical rate of rise of on-state current (1)	Repetitive $F = 50 \text{ Hz}$	20
		Non Repetitive	$\text{A}/\mu\text{s}$
$T_{sig}$ $T_j$	Storage and operating junction temperature range	- 40, + 150 - 40, + 125	°C

Symbol	Parameter	BTA 12-					Unit
		200 AW	400 AW	600 AW	700 AW	800 AW	
$V_{DRM}$	Repetitive peak off-state voltage (2)	± 200	± 400	± 600	± 700	± 800	V

(1) Gate supply :  $I_G = 750 \text{ mA}$  -  $di_G/dt = 1 \text{ A}/\mu\text{s}$ .(2)  $T_j = 125^\circ\text{C}$ .

BTA 12 AW

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## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R <sub>th</sub> (j - a)	Junction to ambient	60	°C/W
R <sub>th</sub> (j - c) DC	Junction to case for DC	3.3	°C/W
R <sub>th</sub> (j - c) AC	Junction to case for 360 ° conduction angle (F = 50 Hz)	2.5	°C/W

## GATE CHARACTERISTICS (maximum values)

P<sub>GM</sub> = 40 W (t = 10 μs) P<sub>G (AV)</sub> = 1 W I<sub>GM</sub> = 4 A (t = 10 μs) V<sub>GM</sub> = 16 V (t = 10 μs).

## ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions			Quadrants	Min.	Typ.	Max.	Unit
I <sub>GT</sub>	T <sub>j</sub> = 25 °C	V <sub>D</sub> = 12 V	R <sub>L</sub> = 33 Ω	I-II-III	2		75	mA
	Pulse duration > 20 μs							
V <sub>GT</sub>	T <sub>j</sub> = 25 °C	V <sub>D</sub> = 12 V	R <sub>L</sub> = 33 Ω	I-II-III			1.5	V
	Pulse duration > 20 μs							
V <sub>GD</sub>	T <sub>j</sub> = 125 °C	V <sub>D</sub> = V <sub>DRM</sub>	R <sub>L</sub> = 3.3 kΩ	I-II-III	0.2			V
	Pulse duration > 20 μs							
I <sub>H</sub> *	T <sub>j</sub> = 25 °C	I <sub>T</sub> = 100 mA					75	mA
	Gate open	R <sub>L</sub> = 140 Ω						
I <sub>L</sub>	T <sub>j</sub> = 25 °C	V <sub>D</sub> = 12 V	I <sub>G</sub> = 500 mA	I-III		75		
	Pulse duration > 20 μs			II		150		mA
V <sub>TM</sub> *	T <sub>j</sub> = 25 °C	I <sub>TM</sub> = 17 A	t <sub>p</sub> = 10 ms				1.6	V
I <sub>DRM</sub> *	T <sub>j</sub> = 25 °C	V <sub>DRM</sub> rated	Gate open				0.01	
	T <sub>j</sub> = 125 °C						2	mA
dV/dt*	T <sub>j</sub> = 125 °C	Gate open						
	Linear slope up to 0.67 V <sub>DRM</sub>							
(dI/dt) <sub>c</sub> *	T <sub>j</sub> = 125 °C	V <sub>DRM</sub> rated						
	Without snubber							
t <sub>gt</sub>	T <sub>j</sub> = 25 °C	dI <sub>G</sub> /dt = 3.5 A/μs	I <sub>G</sub> = 500 mA	I-II-III		2		μs
	I <sub>T</sub> = 17 A	V <sub>D</sub> = V <sub>DRM</sub>						

\* For either polarity of electrode A<sub>2</sub> voltage with reference to electrode A<sub>1</sub>.

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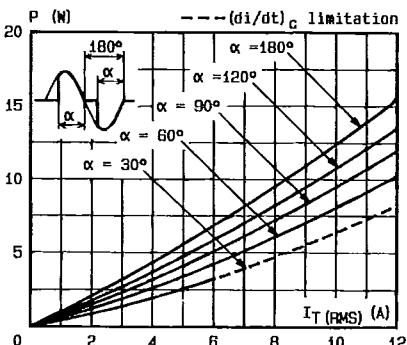


Fig.1 - Maximum mean power dissipation versus RMS on-state current (F = 60 Hz).

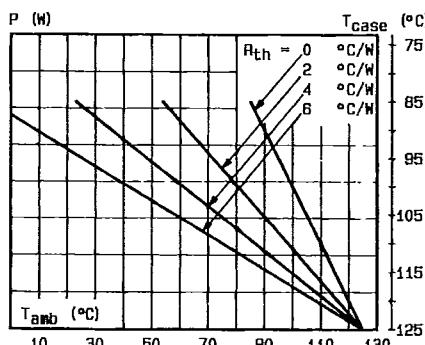
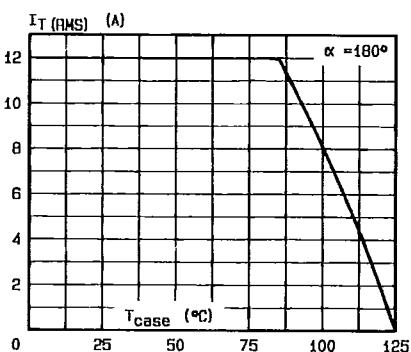
Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T<sub>amb</sub> and T<sub>case</sub>) for different thermal resistances heatsink + contact.

Fig.3 - RMS on-state current versus case temperature.

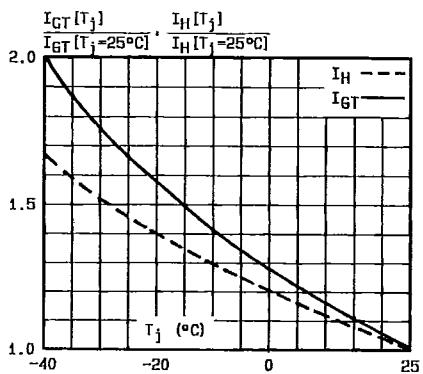


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

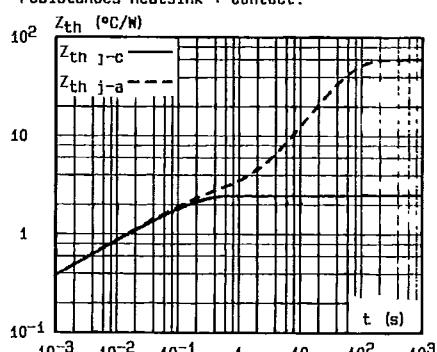


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

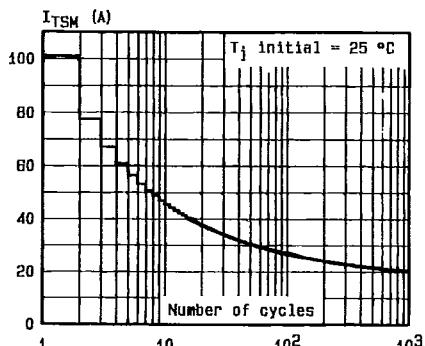


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

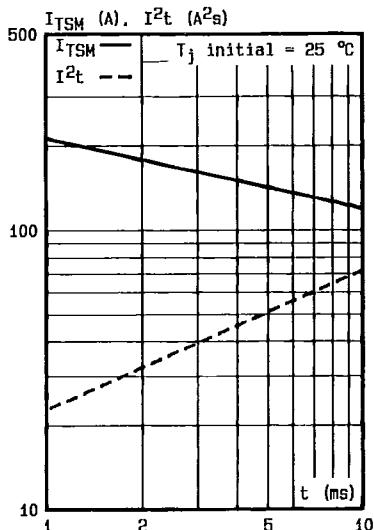


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

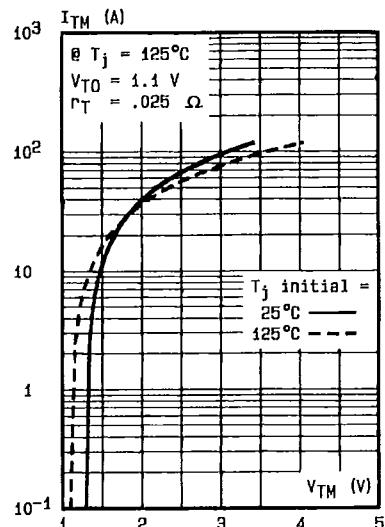
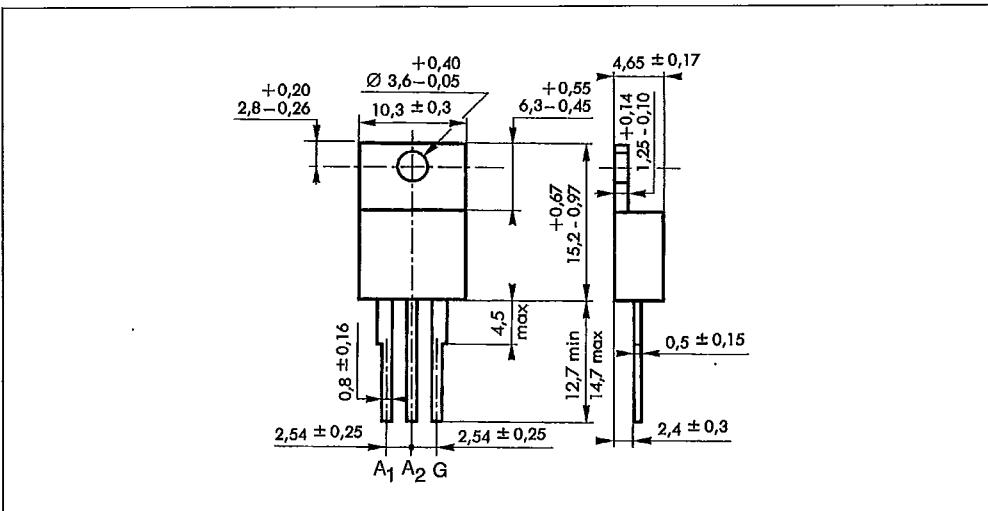


Fig.8 - On-state characteristics (maximum values).

## PACKAGE MECHANICAL DATA

TO 220 AB (CB-415) Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g